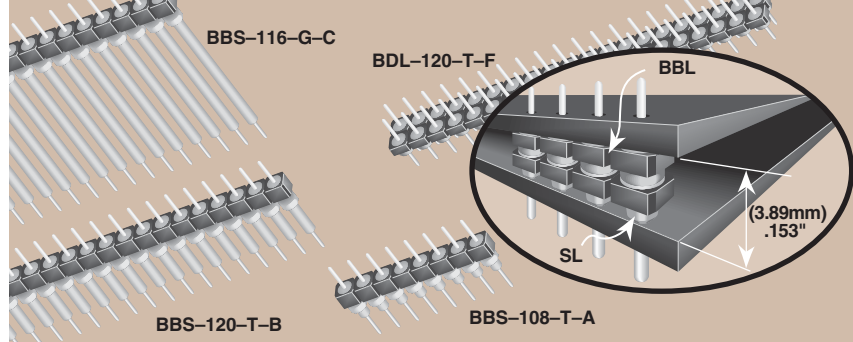


(2,54 mm) .100"

BBS, BBL, BHS, BBD, BDL SERIES



MACHINED BOARD STACKING STRIPS

Mates with:
SS, SD, HSS, SL, SDL,
ESS, ESD

FEATURES

- Low profile design achieves (3,89 mm) .153" board spacings when mated with SL Series.
- Choice of precision machined (BXX Series) or coined (LBS Series) terminals.
- Approach the reliability of a permanent connection with the flexibility of a separable connection.

SPECIFICATIONS

For complete specifications see www.samtec.com?BBS,
www.samtec.com?BBD,
www.samtec.com?BBL or
www.samtec.com?BDL

BBS, BBD, BBL, BDL



Insulator Material:
Black Glass Filled Polyester
(BBS, BBD, BBL)
Black High Temp Nylon (BDL)

Temperature Range:
-55°C to +125°C

Terminal Material:
Phosphor Bronze or Brass

Plating:
Au or Sn over 50µ" (1,27 µm) Ni

Current Rating:
1A per contact

RoHS Compliant:
Yes

Lead-Free Solderable:
Yes

Wave only

SPECIFICATIONS

For complete specifications see www.samtec.com?BBS

BBS

Same as BBS except:

Insulator Material:
Black Liquid Crystal Polymer

RoHS Compliant:
Yes

Lead-Free Solderable:
Wave, or reflow with all Au

Note: Some lengths, styles and options are non-standard, non-returnable.

TYPE STRIP	1	NO. PINS PER ROW	PLATING OPTION	LEAD STYLE
BBS = Standard Single Row BBL = Low Profile Single Row BHS = High Temp Single Row			-G =20 µ" (0,51 µm) Gold -T =Tin	
BBD = Standard Double Row BDL = Low Profile Double Row			01 thru 32 = BBS & BBL 01 thru 36 = BBD, BDL & BHS	

-A Z = (5,33 mm) .210"	-B Z = (8,51 mm) .335"	-C Z = (14,86 mm) .585"	-E Z = (1,78 mm) .070"	-F Z = (2,16 mm) .085"
BBS and BHS Series	BBD Series		BBL Series	BDL Series

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM